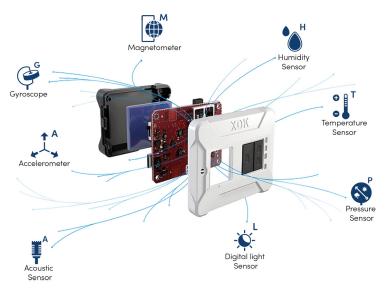
LEGIC

LEGIC XDK110

IloT Sensor Module with 8 Sensors Bluetooth® and Wi-Fi



- Enables rapid prototyping and fast transition from prototype to mass production
- Integrates eight MEMS sensors, Bluetooth, Wi-Fi
- Software included: XDK
 Workbench, extensive libraries & modular source code,
 example firmware for Azure
 integration



Actual size: 60 x 40 x 22 mm

Universal programmable sensor & prototyping platform for any IoT use case you can imagine!

LEGIC XDK110 allows rapid prototyping of securely managed sensor-based applications that support basic to advanced IIoT solutions.

Powerful IoT prototyping module

All-in-one sensor kit: no need for component selection, hardware assembly, or deployment of a real-time operating system. Kit includes accelerometer, acoustic, light, gyroscopic, humidity, magnetometer, pressure and temperature sensors.

Development environment, algorithm library, example code, secure data protocol and drivers are included. Perfect for short-term proof-of-concept or long-term projects.

Integration with MS Azure

XDK110 can be securely managed and monitored via the Microsoft Azure cloud platform. Example firmware is included for Azure integration.

Integration with LEGIC Connect

For applications requiring mobile credentialing, a separate XDK Secure Sensor Evaluation Kit including LEGIC SM-6310 Security Module is available. With it, user interactions with the XDK110 can be securely managed and monitored via the LEGIC Connect end-to-end mobile security platform.

Off-the-shelf expertise

Need help with your design or mass production? Take advantage of LEGIC's 300+ global Partner Network of Design Houses, System Integrators and OEM Manufacturers.

Our partners are experts in LEGIC technology including end-to-end security, virtual key management and mobile credentialing. They can help you design and bring your IoT sensor solution to production quickly and cost-effectively: www.legic.com/partners

Benefits and features

- All-in-one IoT sensor kit: no need for component selection, hardware assembly, or deployment of a real-time operating system
- Integrated Bluetooth and Wi-Fi
- Algorithm library
- Example code in open source licensing
- Drivers for all system components included
- Secure data protocol
- Built-in lithium ion rechargeable battery
- Functional extendibility via the included mobile credentialing interface extension board
- High-level API for the standard user and low-level API for the power user
- PC and MAC based development tools for Windows, LINUX and MacOS make it an easy to work with tool for any devel-
- CE, FCC, IC, IMDA, ACMA, NTC and NBTC certified
- Small form factor: length 60 mm x width 40 mm x height 22 mm; weight 54 g



Technical data

LEGIC SDK110 IIoT Sensor Module

XDK110 contents

- LEGIC XDK110 with 32-Bit microcontroller (ARM Cortex M3), 1 MB Flash, 128 kB RAM, Li-Ion rechargeable 560 mA battery, integrated antennas and extension slot for support of additional functionalities'
- Breakout-board for easy access to additional MCU functionality
- Micro USB 2.0 connector cable
- 10 cm connector cable, mounting plates and screws

Software

Free software download for XDK at www.xdk.io

- XDK Workbench integrated development environment for Linux, Mac and Windows
- Extensive libraries and modular source code to enable developers to fully understand the system
- Ready-to-use example firmware for MS Azure integration
- LWM2M communication protocol
- User Guide

User interfaces

- Power switch
- Green system LED to display the state of charging
- 3 programmable status LEDs (red, orange, yellow)
- 2 programmable push-buttons
- Micro SD card slot
- Interface for J-Link Debug-probe
- Interface for extension board

Wireless interfaces

Bluetooth Wi-Fi

- V4.0 Bluetooth Low Energy IEEE 802.15.
- Wireless LAN IEEE 802.11b/g/n SO 14443 A + B

Measurement ranges

Accelerometer Gyroscope

Magnetic field strength

Light sensor

Temperature sensor

Pressure sensor

Humidity sensor

■ ±2 to ±16 g (programmable)

■ ±125 °/s to ±2000 °/s (programmable)

±1300 μT (X,Y-Axis); ±2500 μT (Z-Axis)

• 0.045 lux to 188,000 lux; 22-bit

■ -20 °C to 60 °C

300 to 1100 hPa**

10...90 %rH (non-condensing)**

Sampling rate

Accelerometer BMA280 Gyroscope BMG160 Magnetometer BMM150 Hum./Press./Temp. BME280

Inertial Measurement BMI160

■ 2000 Hz

■ 2000 Hz

■ 300 Hz

■ 182 Hz

■ 1600 Hz (Accelerometer)

■ 3200 Hz (Gyroscope)

Operating conditions***

Operating voltage

Operating current Operating temperature

Storage temperature

Humidity **IP Rating**

■ 50V

■ 1.8 µA to 5 mA (sensor and mode dependent)

-20 °C to 60 °C, (0 °C to 45 °C for battery charging)

■ -20 °C to 60 °C

• 10 to 90 %rH (non-condensing)

■ IP 30 (IEC 60529)

- Example: LEGIC mobile credentialing extension board
- Limited by XDK operating condition Recommended for indoor use only





